	1	2	2	3		4	5	1	6
	Product Name: 2			1 Key E passi	ve breakout a	idapter - power r	measurement module	and the second of the second of the second s	1 martin
		– Page	1 of 3					Construction of the local division of the lo	Transfer wanted
F	Product Description: ZX122S1EPS is PCISIG M.2 breakout adapter providing access to all PCISIG signals as well as providing method of power supplies test and measurement. ZX122S1EPS is breakout adapter to be used for :								
	a) Each b) Each	neasurement for signal qu PCISIG (excluding GND 0402 SMD shunt package 0402 SMD shunt package	signals) are routed to 04 e may be wired for signal	402 SMD shunt pa measurement via	ackage for easy p a scope / test equ	probe access. ipment.	SMD shunt landing pads.	ZEBAX ZX122	.com S1EPS
E	a) Each b) Utilizin c) Utilizin d) Identi ZX122S1EP 1- Provides	s access to ALL PCISIG s	ned with current sensing lipment , measure power d) , qualify host's power edance, Rdc , for improv ignals via onboard 0402	power resistor, p supply noise, rip supply & maximu red Host / DUT PC	lease see block o ples, transients, a im output power. CB design. ages	liagram.	umption.	R1	
	3- Listed n 4- All trace 5- Four lay 6- Accessil	d current sense resistors foumber adjacent to each 0- s are 50 Ohms impedance ers PCB design, inner lay ble GND exposed copper,	402 SMD shunt package e controlled. ers are GND planes. enabling for ease of acc	represents the as	ssociated PCISIC	à M.2 connector's pin	number.	2 2 22	R29
Ί		ith any key matching M.2 dule is shipped with 12pc		C2PH30 See or	dering informatio	n			Figure 1 - ZX
								rcuit diagram	Block diagrar
	Electrical: Ins	ertion loss > -2dB @6GH	Z			solid copper to pin header wir nbly , ZX00BC2PH30 Zebax.c			J2
C	Tra Op M.2 M.2	the impedance: 50Ω erating Temperature: -65 2 Edge Connector type (J Mates with: M.2 Key E Plating: Gold 100U 2 Receptacle (J2): Key Type: Key E Height: 0.16" (4.2mm) Spacer : 0.1" (2.54mm) – Plating: Gold 100U Current per pin: 0.5A (m rrent Sense:	℃ to +170℃ 1): Key E - See Figure 3	(2.54mm) TUQ	1.2 receptacle	Rsense 0.02" (0.5mm)		R2 10mΩ	R1, R2: current sense 51 54. PCISIGN cor routed to the 0402 SM
3	Shi	R1,R2 : 10mΩ 2512 SME Ratings: AEC-Q200 Temperature Coefficient: Operating Temperature:-	±75ppm / °C	listed power rating	g, see Table 1		ed ree	ZX122S1EPS part number ZX122S1EPS ZX00BC2PH30	PCB Edge J2 Key E Key E
		sistors: Table 1 li sociated PCISIG M.2 conr	sts onboard ZX122S1EP nector assignment	PS current sense r	resistors and		per IEC-61249-2.21 : 2003 2011/65/EU		ZX00BC2PH30
1	Table 1		-		Dealerer		· · ·		SAL
Δ	Current Sense Resist R1 R2	PCISIG M.2 Connector pinnumber 2, 4 72, 74	3.3 V 1	0m Ohms 1% 7W	Package (inch) (mm) 2512 6432 2512 6432	Certificate of Co Certificate of Co Certificate REA			WW SPE ARE ROI
	Notice						ompliance RoHS_EN_CoC		
		N SPECIFICATIONS, DRAWINGS, PUBLI ISE WITH RESPECT TO THE MATERIAL					X MAKES NO WARRANTIES, EXPRESSED, R A PARTICULAR PURPOSE.		DE

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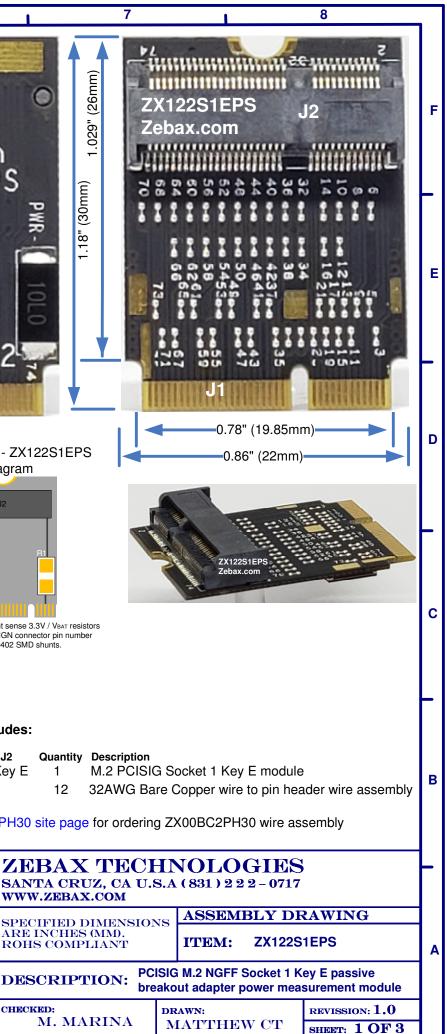
С

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В

Α

	ZX122S1EPS p	backage in	cludes:
Directive 2000/EC)	Part number ZX122S1EPS ZX00BC2PH30	PCB Edge Key E	J2 Key E
/e (203/11/EC) 1249-2.21 : 2003 /EU		ZX00BC	C2PH30
12/EU) e for Radioactive substar	nces		ZE SAN WWW
e for Asbestos			



	1 2 3 4	5	1	6	7	8	
				Device I	Under Test, DUT	ZX122S1EPS	
	Product Name: ZX122S1EPS PCISIG M.2 NGFF Socket 1 Key E passive breakout adapter - power	er measurement module – Pa	ige 2 of 3			By	
F	Current Sense resistors: The current sense resistors may be removed if external electronic load, eLoad, is used. eLoad test equipment may be applied to ZX122S1EPS for power supply						
	characterization, test and measurements. Eload suppliers : BK Precision, Chroma, Instek, Kikusui and more			Figu	ure 4 – Typical application - Rx, Ry	Rx : Current sense resistors	
		Table 2 – PCISIG M.2 Socket Table 2 represents only the PCISIG I	,	y E power su	pply and the assigned GND ,		
$\left - \right $	PCISIG M.2 reference ground, signal assignments for "Socket 1 Key E" applications.						
	1- Table 2 represents only the PCISIG M.2 Socket 1 Key E power supply and the assigned GND, PCISIG M.2 reference ground, signal assignments for "Socket 1 Key E" applications.		PCISIG M.2 c				
	2- Table 2 represents only the PCISIG M.2 Socket 1 Key E signal assignments for the listed application.	Signal	Pin Label ¹	S1EPS Label ¹ Pin			
E	However; there are other PCISIG signal assignment for the M.2 Socket 1 Key E design configuration.	3.3 V 3.3 V	74 72 R2 ²	75 73 73		E	
	All PCISIG M.2 assigned Power Supply rails and GND reference M.2 pin assignments are identical across PCISIG M.2 Socket 1 Key E solutions. Please apply your design signal name convention to non-power	UIM_POWER_SRC/GPIO_1/PEWAKE1# UIM_POWER_SNK/CLKREQ1#	70 70 68 68	71 71 69			
	supply rail signals as the listed signal names on the Table 1 applies to the listed specific M.2 application.	UIM_SWP/PERST1# RESERVED	66 66 64 64	67 67 65 65	RESERVED/PETn1		
	Ground / Exposed Copper :	ALERT# (O)(0/1.8 V) I2C CLK (I)(0/1.8 V)	62 62 60 60	63 61 61	GND	== L	
	All of the PCISIG M.2 GND , reference ground , signals are connected to each other along with the 2 inner GND planes. In addition; the exposed copper on the ZX122S1EPS is the module's GND for purpose of	I2C_DATA (I/O)(0/1.8 V)	58 58	59 59	RESERVED / PERp1		
	rework and probing purpose.	W_DISABLE1# (I)(0/3.3V) W_DISABLE2# (I)(0/3.3V)	56 56 54 54	57 55 55	PEWAKE0# (I/O)(0/3.3V)		
	PCISIG M.2 signals :	PERST0# (I)(0/3.3V) SUSCLK (I)(0/3.3V)	52 52 50 50	53 53 51	GND		
ĽГ	ZX122S1EPS passes through all PCISIG M.2 signals (excluding the power supply rails . All traces are 50	COEX_RXD (I)(0/1.8V) COEX_TXD (O)(0/1.8V)	48 48 46 46	49 49 47 47		D	
	Ohms impedance controlled. ZX122S1EPS passes through the reserved "NC" No Connect signals as well.	COEX3 (I/O)(0/1.8V) VENDOR DEFINED	44 44 42 42	45 43 43			
		VENDOR DEFINED VENDOR DEFINED	40 40 38 38	41 41 39			
	Application: Bringup, testing, emulation, development, modular design evaluations	UART_CTS (I)(0/1.8V) UART_RTS (O)(0/1.8V)	36 36 34 34	37 37 35 35	PERn0		
	M.2 PCISIG Socket power supply test characterization	UART_RXD (I)(0/1.8V)	32 32	33	GND		
	SDIO SSD SATA WWAN DP WIFI GPS GYRO Compass BT FM sensor module Socket 1 Add-in Card Key E-E , Socket 1 DisplayPort Key E , Socket 1 SDIO Key E	ADD-IN CARD KEY E ADD-IN CARD KEY E	30 30 28 28	31 31 29 29	ADD-IN CARD KEY E		
	Socket 2 WWAN Key C , Socket 2 PCIe-based SSD Key B-M , Socket 2 SATA-based SSD Key B-M	ADD-IN CARD KEY E ADD-IN CARD KEY E	26 26 24 24	27 27 25 25	ADD-IN CARD KEY E		
C	Socket 2 PCIe / USB 3.1 Gen1-Based WWAN Key B , Socket2 PCIe-Based WWAN Key B Socket 2 USB3.1 Gen1-based WWAN Key B , Socket 2 SSIC WWAN Key B	UART_TXD (O)(0/1.8V) UART_WAKE# (O)(0/3.3V)	22 22 20 20	23 23 21 21	SDIO_WAKE# (O)(0/1.8V)	<u>SV)</u>	
	Socket 3 PCIe-based Key M , Socket 3 SATA-based Key M	GND LED_2# (O)(OD)	18 16 16	19 19 17 17	= , , , ,		
		PCM_IN/I2S_SD_IN (I)(0/1.8V) PCM_OUT/I2S_SD_OUT (O)(0/1.8V)	14 14 12 12	15 15 13 13	= ; ;; ;		
		PCM_SYNC/I2S_WS (I/O)(0/1.8V) PCM_CLK/I2S_SCK (I/O)(0/1.8V)	10 10 8 8	11 11 9 9		— –	
	Mates with : Any standard M.2 NGFF PCISIG connector on host and device Key E TE 2199125 2199119 2199230 2199133 JAE SM3ZS067	LED_1# (O)(OD) 3.3 V	6 6 4 - 2	7 5 5	GND USB D-		
	Bellwether: SD-80148 SD-80149 SD-80152 SD-80159 Amphenol	3.3 V	2 R1 ²	3 3 1	USB_D+ GND		
в		Note 1: Label is the labled number on the adjacent 04				Iry B	
	Module Insertion, Removal process:	depending to your M.2 design configuration. Pl 2: The supply power is available on the listed cu		signai name conventi	ion to non-power supply fail signals & CIND.		
	In order to avoid any mechanical stress or damage to ZX122S1EPS, please follow the below listed guidelines for insertion and removal process:						
	1- Move the Module against the housing chamber, see figure 1				ZEBAX TECHN	OLOGIES	
11	2- Rotate module to 25°, insert it until the module surface reaches the ramp, figure 2, 3				SANTA CRUZ, CA U.S.A		
	 3- Rotate the module to horizontal position, see figure 4 4- Fix the module by screw, see figure 5 				WWW.ZEBAX.COM	ASSEMBLY DRAWING	
	Sorew Fig. 4				ARE INCHES (MM).	ITEM: ZX122S1EPS	
Α	Notice					A	
					M.2 NGFF Socket 1 Key E passive at adapter power measurement module		
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ᆝ└	1 2 3 4	5	I	6	7	ATTHEW CT SHEET: 2 OF 3	

	1	2		3		4		5	6		
	Product Name: ZX12	22S1EPS PCISIG M.2	NGFF Socket	1 Key E passive	breakout ad	lapter - pow	er measuremer	nt module – Page 3	of 3		
F	Typical Application:	ZX122S1EPS is designed f connector's bandwidth. It pr measuring characterization resistors may be replaced to proper power supply me	rovides onboard data for qualifyin by eLoad for tran	current sense resistong the host or device nsient and dynamic loa	rs where scope functional beha ad throttling. Be	probe could be vior. Additionall	e utilized for y, the current sens				
	Scope Probe wire Installation: Utilize the supplied ZX00BC2PH30 bare copper to pin wire assembly whenever possible – Based on availability of type of							Keysight Probe Head accessories			
Е	1- It is re	probing options, install prob ecommended to keep the +pr ler to avoid ground loop prob	obe wire length a	at 0.5" (1.2cm) long.	probe wire inter	facing to the ne	earest GND	MX0100A Diff. Mi MX0103A Bullet			
	referei 3- Ensui indusi	ler to avoid ground loop problems, please use the shortest Ground probe wire interfacing to the nearest GND nce. ZX122S1EPS provides several exposed copper test points for probing purpose. re scope probe's bandwidth is set at 20MHz – Certain tests require full scope + scope probe bandwidth; however, try standard is 20MHz bandwidth for power supply test and measurements.						MX0106A Diff. Solder	-In N5380B SMA		
		Keysight as well as Tektronix are few probes from each ve	endor:			-		N2839A Diff. Browser	N5425B ZIF N		
D	4- Pleas	 a) Keysight differential prob probe, N5426A ZIF Tip, I b) Tektronix offers several s P6247 or any TP1500, T ce follow your vendor's guidel 	N2884A Fine Win single-ended as v AP2500, TAP35	re ZIF Tip and more – well as differential pro 500, TAP4000, P7240	See the figure ' bes such as : P of TDP7000 se	"probe head aco 6243, P6245, P	cessories". 6248, P6246,	MX0105A Diff. SMA			
_	highly recommended to utilize external cooling fan if your design expects to exceed maximum current via each PCISIG M.2 pin (0.5A per pin) at above 85 °C test environment.								Tektronix P6243 scop		
с	The onboard current sense resistors operate at 100% listed power ratings (see Table 1) within temperature range : R1, R2 : -65 ℃ ≤ operating temperatures ≤ 85 ℃ with tolerance = ±1% The onboard current sense resistors power ratings derail at above 85 ℃. Figure 4 exhibits the current sense resistors derating curve. Current sense resistors rated power ; P = VI = I**2 x R where I is the maximum current for the listed resistor value R										
		re few suggestions, if your te				-	te - The 7X122S1E	PS module design			
в	 Apply cooling fan where the current sense resistor's terminal blocks are measured at 85 °C – Please note - The ZX122S1EPS module design provides heatsink solution to the onboard current sense resistors via inner layers thermal distribution method. Replace the onboard current sense resistors with lower values (similar footprint), resulting at higher power ratings at ≥ 85 °C test environment. Replace onboard current sense resistors with eLoad (electronic Load Board / System) – eLoad system resides outside of test chamber, therefore it is not subject to temperature degradation. 										
	Figure 4 – Current sense resistor Derating chart										
_	100 % 100 % 800 0 1 0 0 0 0 0 0 0 0 0 0 0 0 0	R1, R2							ZEF SANT WWW.		
Α	0 -60 -40 -20 0 20 -65 Current source resisto	40 60 80; 100 120 140 160 180 85 r terminal – Temperature ℃ ¹⁷⁰							SPECI ARE IN ROHS		
	Notice ALL ZEBAX TECHNOLOGIES DESIGN SPECI								DESC		
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	1	2		3	I	4	I	5	6		

